



Typical unit

### FEATURES

- Standard quarter-brick package/pinout in through-hole version
- Low cost; Low profile, 0.43”(10.92mm)
- 9-36V or 18-75V wide range inputs
- Output current: 4 to 25 Amps
- Output voltages: 3.3, 5, 12, 15 or 24V
- Interleaved synchronous-rectifier topology
  - Ultra high efficiency
  - No output reverse conduction
- Outstanding thermal performance
- On/off control, trim & sense functions
- Fully isolated, up to 2250Vdc (48 V<sub>IN</sub>)
- Output overvoltage protection
- Fully I/O protected; Thermal shutdown
- Certified to UL/EN/IEC60950-1, 2nd Edition safety approvals
- RoHS hazardous substance compliant

### PRODUCT OVERVIEW

From an 9-36V or 18-75V input, UQQ's deliver outputs of 3.3V, 5V, 12V, 15V, or 24V. They employ an interleaved, synchronous-rectifier topology that exploits 100% of their duty cycle. They simultaneously achieve ultra-high efficiency, tight line/load regulation, low noise, and quick step response.

A state of the art, single-board, open-frame design with reduced component count, high efficiency, low-on-resistance FET's, and planar magnetics embedded in heavy-copper pc boards all contribute to impressive thermal derating.

The UQQ's feature set includes high isolation, input pi filters, input undervoltage shutdown, output overvoltage protection, current limiting, short-circuit protection and thermal shutdown. The standard footprint carries on/off control (positive or negative polarity), output trim (+10/-20%) and output sense functions.

All UQQ quarter-bricks are designed with full magnetic and optical isolation up to 2250 Volts DC (basic insulation).

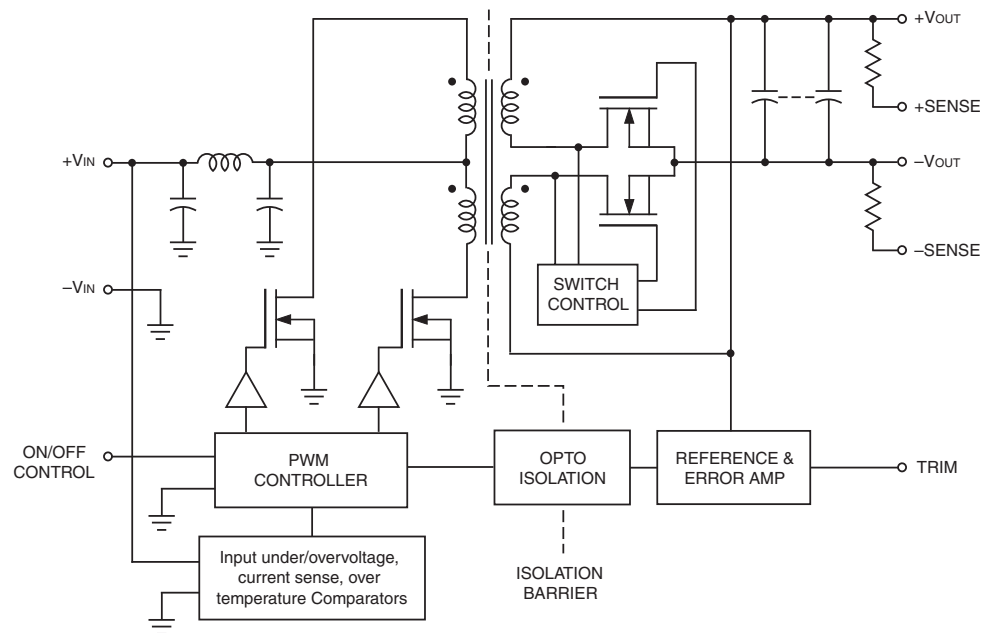


Figure 1. Connection Diagram

Typical topology is shown.



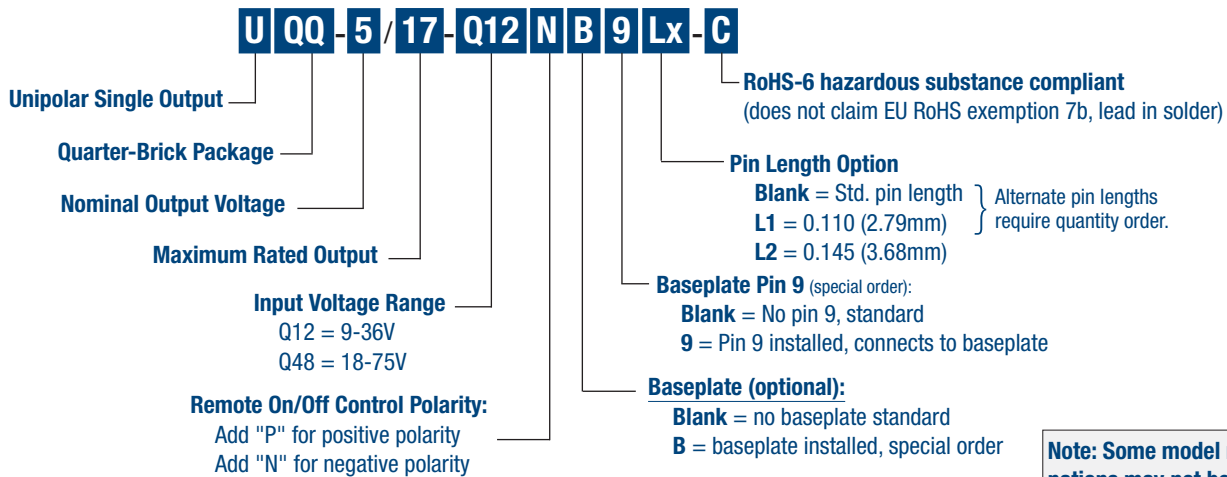
**Performance Specifications and Ordering Guide** ①

PERFORMANCE SPECIFICATIONS AND ORDERING GUIDE														
Root Model ③	Output						Input				Efficiency		Package (Case/ Pinout)	
	V <sub>OUT</sub> (V)	I <sub>OUT</sub> (A)	Power (Watts)	R/N (mVp-p)		Regulation		V <sub>IN</sub> Nom. (Volts)	Range (Volts)	I <sub>IN</sub> , no load (mA)	I <sub>IN</sub> , full load (A)	Min.		Typ.
				Typ.	Max.	Line	Load							
UQQ-3.3/25-Q12P-C	3.3	25	82.5	50	80	±0.05%	±0.125%	12	9-36	180	7.81	86%	88%	C68,P32
UQQ-3.3/25-Q48N-C	3.3	25	82.5	80	125	±0.05%	±0.2%	48	18-75	80	2.01	86%	88%	C68,P32
UQQ-5/17-Q12P-C	5	17	85	40	75	±0.05%	±0.06%	12	9-36	150	7.83	88.5%	90.5%	C68,P32
UQQ-5/20-Q48N-C	5	20	100	100	140	±0.05%	±0.165%	48	18-75	65	2.47	82.5%	84.5%	C68,P32
UQQ-12/8-Q12P-C	12	8	96	40	75	±0.05%	±0.05%	12	9-36	180	8.99	87%	89%	C68,P32
UQQ-12/8-Q48N-C	12	8	96	120	160	±0.05%	±0.1%	48	18-75	70	2.3	85%	87%	C68,P32
UQQ-15/7-Q12P-C	15	7	105	56	100	±0.05%	±0.1%	12	9-36	250	9.78	88%	89.5%	C68,P32
UQQ-24/4-Q12P-C	24	4	96	125	170	±0.05%	±0.075%	12	10-36	120	8.99	87.7	89%	C68,P32

- ① Typical at TA = +25°C under nominal line voltage and full-load conditions. All models are specified with an external 1µF multi-layer ceramic and 10µF capacitors across their output pins and 100µF external input capacitor.
- ② Ripple/Noise (R/N) measured over a 20MHz bandwidth.
- ③ Devices have no minimum-load requirements and will regulate under no-load conditions. Regulation specifications describe the output voltage deviation as the line voltage or load is varied from its nominal/midpoint value to either extreme. (Load step = 50%.)

- ④ Nominal line voltage, no load/full load condition.
- ⑤ Please refer to the Part Number Structure for additional part numbers and options.
- ⑥ RoHS does not claim EU exemption 7B—lead in solder.

**PART NUMBER STRUCTURE**



Some model options may require minimum order quantities.

**Note: Some model number combinations may not be available. Contact Murata Power Solutions.**

**Pin 9 Baseplate Connection**

The UQQ series may include an optional installed baseplate for extended thermal management. This baseplate is electrically isolated from the rest of the converter. Various UQQ models are also available with an additional pin 9 on special quantity order which electrically connects to the baseplate. Pin 9 is also isolated from the rest of the converter. Please refer to the mechanical drawings.

Pin 9 offers a positive method of controlling the electrical potential of the baseplate, independent of the converter. If you do not include pin 9, the baseplate may also be grounded by the mounting bolts.

The baseplate may be ordered by adding a "B" to the model number tree and pin 9 will be pre-installed by adding a "9". The two options are separate. Please refer to the Ordering Guide. **Do not order pin 9 without the baseplate.** Note that "pin 9" converters may be on limited forecast, requiring minimum order quantities and scheduled deliveries.

Please see page 9 for heatsink information.

### Performance and Functional Specifications

	UQQ-3.3/25-Q12	UQQ-3.3/25-Q48	UQQ-5/17-Q12	UQQ-5/20-Q48	UQQ-12/8-Q12
<b>INPUT</b>					
<b>Input Voltage Range</b>	See ordering guide				
<b>Start-up Threshold</b>	9.0 Volts	17.50 Volts	9.0 Volts	17.5 Volts	9.0 Volts
<b>Undervoltage Shutdown</b>	8.0 Volts	16.75 Volts	8.0 Volts	15.75 Volts ( $I_{OUT} = 0A$ )	8.0 Volts
<b>Overvoltage Shutdown</b>	37.5 Volts	None	37.5 Volts	None	37.5 Volts
<b>Reflected (back) ripple current (2)</b>	25mA <sub>p-p</sub>	15mA <sub>p-p</sub>	75mA <sub>p-p</sub>	80mA <sub>p-p</sub>	75mA <sub>p-p</sub>
<b>Input Current</b>					
Full load conditions	See ordering guide				
Inrush transient	0.1A <sup>2</sup> sec				
Output short circuit	250mA	100mA	100mA	50mA	250mA
No load	150mA	80mA	150mA	65mA	180mA
Low line ( $V_{IN} = \text{min.}$ )	10.4 Amps	5.18 Amps	10.44 Amps	6.24 Amps	12.12 Amps
Standby mode (Off, UV, OT shutdown)	8mA	2mA	8mA	5mA	5mA
<b>Internal Input Filter Type</b>	LC	Pi-type	L-C	L-C	L-C
<b>Reverse Polarity Protection</b>	External Fusing Required (15)	External Fusing Required (15)	External Fusing Required (15)	External Fusing Required (15)	External Fusing Required (15)
<b>Remote On/Off Control (5)</b> Positive logic ("P" suffix)	OFF = Ground pin to +0.8V max. ON = open or +3.5-15V max.				
Negative logic ("N" suffix)	OFF = open or +5 to + $V_{IN}$ max. ON = Ground pin to +0.8V max. (16)				
<b>On/Off Current</b>	1 mA	1 mA	1 mA	1mA	1 mA
<b>OUTPUT</b>					
<b>Voltage Output Range</b>	See ordering guide				
<b>Voltage Output Accuracy</b> (50% load)	±1% of $V_{NOM}$				
<b>Adjustment Range</b>	±10% of $V_{NOM}$	±10% of $V_{NOM}$	-20 to +10% of $V_{NOM}$	-20 to +10% of $V_{NOM}$	-20 to +10% of $V_{NOM}$
<b>Temperature Coefficient</b>	±0.02% of $V_{OUT}$ range/°C				
<b>Minimum Loading</b>	No minimum load				
<b>Remote Sense Compensation</b>	+10%				
<b>Ripple/noise (20MHz bandwidth)</b>	See ordering guide				
<b>Line/Load Regulation</b>	See ordering guide				
<b>Efficiency</b>	See ordering guide				
<b>Maximum Capacitive Loading</b> Low ESR <0.02Ω max., resistive load	10,000μF	4700μF	10,000μF	10,000μF	4700μF
<b>Isolation Voltage</b>					
Input to Output	2000 VDC min.	2250 VDC min.	2000 VDC min.	2250 VDC min.	2250 VDC min.
Input to baseplate	1500 VDC min.	1500 VDC min.	1500 VDC min.	1500 VDC min.	1500 VDC min.
Baseplate to output	1500 VDC min.	500 VDC min.	750 VDC min.	1500 VDC min.	750 VDC min.
Isolation resistance	100MΩ	100MΩ	100MΩ	100MΩ	100MΩ
Isolation capacitance	1500 pF	1000 pF	1000 pF	1500pF	1000 pF
Isolation safety rating	Basic insulation				
Current limit inception (98% of $V_{out}$ , after warmup)	30 Amps	29 Amps	20.5 Amps	27 Amps	9.5 Amps
<b>Short Circuit Protection Method</b>	Current limiting, hiccup autorestart. Remove overload for recovery.				
<b>Short Circuit Current</b>	5 Amps	5 Amps	3 Amps	0.5 Amps	0.5 Amps
<b>Short Circuit Duration</b>	Continuous, output shorted to ground (no damage)				
<b>Overvoltage Protection</b> via magnetic feedback	4 Volts	3.96 Volts max.	6 Volts	6 Volts	14.4 Volts

### Performance and Functional Specifications (continued)

	UQQ-12/8-Q48	UQQ-15/7-Q12	UQQ-24/4-Q12
<b>INPUT</b>			
<b>Input Voltage Range</b>	See ordering guide		
<b>Start-up Threshold</b>	17.5 Volts	9.0 Volts	9.0 Volts
<b>Undervoltage Shutdown</b>	16.0 Volts	8.0 Volts	8.0 Volts
<b>Overvoltage Shutdown</b>	None	38.5 Volts	None
<b>Reflected (back) ripple current (2)</b>	15mA <sub>p-p</sub>	50mA <sub>p-p</sub>	50mA <sub>p-p</sub>
<b>Input Current</b>			
Full load conditions	See ordering guide		
Inrush transient	0.1A <sup>2</sup> sec		
Output short circuit	100mA	250mA	250mA
No load	70mA	250mA	120mA
Low line (V <sub>IN</sub> = min.)	5.93A	12.9 Amps	10.73 Amps
Standby mode (Off, UV, OT shutdown)	2mA	5mA	5mA
<b>Internal Input Filter Type</b>	PI-type	L-C	L-C
<b>Reverse Polarity Protection</b>	External Fusing Required (15)	External Fusing Required (15)	External Fusing Required (15)
<b>Remote On/Off Control (5)</b> Positive logic ("P" suffix)	OFF = Ground pin to +0.8V max. ON = open or +3.5-15V max.		
Negative logic ("N" suffix)	OFF = open or +5 to +V <sub>IN</sub> max. ON = Ground pin to +0.8V max. (16)		
On/Off Current	1 mA		
<b>OUTPUT</b>			
<b>Voltage Output Range</b>	See ordering guide		
<b>Voltage Output Accuracy (50% load)</b>	±1.25% of V <sub>NOM</sub>	±1% of V <sub>NOM</sub>	±1% of V <sub>NOM</sub>
<b>Adjustment Range</b>	-20 to +10% of V <sub>NOM</sub>	-20 to +10% of V <sub>NOM</sub>	±10% of V <sub>NOM</sub>
<b>Temperature Coefficient</b>	±0.02% of V <sub>OUT</sub> range/°C		
<b>Minimum Loading</b>	No minimum loading		
<b>Remote Sense Compensation</b>	+10% of V <sub>out</sub> max.	+10% of V <sub>out</sub> max.	+10% of V <sub>out</sub> max.
<b>Ripple/noise (20MHz bandwidth)</b>			
<b>Line/Load Regulation</b>	See ordering guide		
<b>Efficiency</b>			
<b>Maximum Capacitive Loading</b> Low ESR <0.02Ω max., resistive load	2200μF	4700μF	1500μF max
<b>Isolation Voltage</b>			
Input to Output	2250 VDC min.	2000 VDC min.	2000 VDC min.
Input to baseplate	1500 VDC min.	1500 VDC min.	1500 VDC min.
Baseplate to Output	500 VDC min.	1500 VDC min.	1500 VDC min.
Isolation resistance	100MΩ	100MΩ	100MΩ
Isolation capacitance	1000 pF	1000 pF	1000 pF
Isolation safety rating	Basic insulation		
Current limit inception (98% of V <sub>out</sub> , after warmup)	11.5 Amps	9.5 Amps	5.75 Amps
<b>Short Circuit Protection Method</b>	Current limiting, hiccup autorestart. Remove overload for recovery		
<b>Short Circuit Current</b>	0.1 Amps	0.5 Amps	0.5 Amps
<b>Short Circuit Duration</b>	Continuous, output shorted to ground (no damage)		
<b>Overvoltage Protection</b> via magnetic feedback	15 Volts	18 Volts	29 Volts

<b>Absolute Maximum Ratings</b>		
<b>Input Voltage</b>	<b>12V models</b>	<b>48V models</b>
Continuous	0 to +36V	0 to +75V
Transient (100msec)	+50V	+100V
<b>On/Off Control</b>	0V min to +13.5V max.	
<b>Input Reverse Polarity Protection</b>	Install external fuse.	
<b>Output Overvoltage</b>	V <sub>OUT</sub> +20% max.	
<b>Output Current <sup>(7)</sup></b>	Current-limited. Devices can withstand sustained short circuit without damage.	
<b>Storage Temperature</b>	-55 to +125°C	
<b>Lead Temperature</b>	See soldering guidelines	

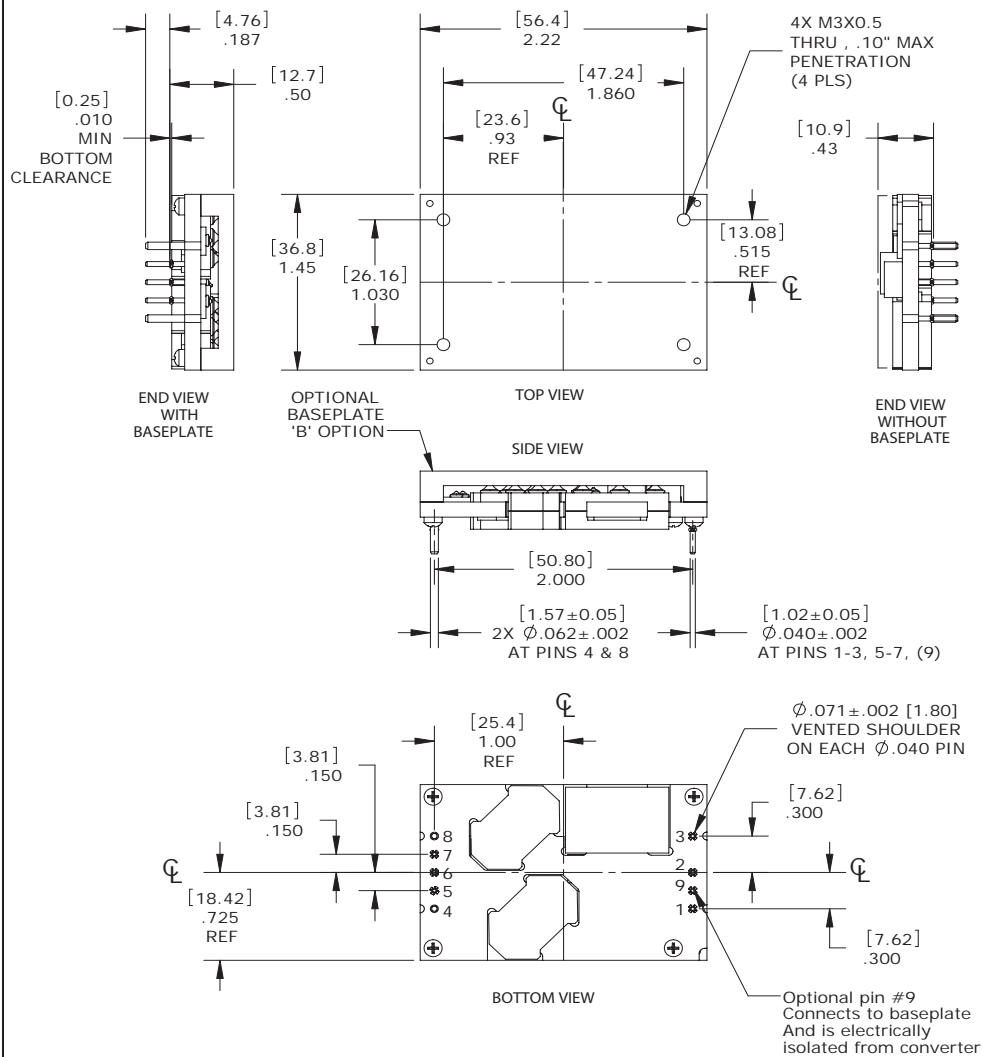
Absolute maximums are stress ratings. Exposure of devices to greater than any of these conditions may adversely affect long-term reliability. Proper operation under conditions other than those listed in the Performance/Functional Specifications Table is not implied or recommended.

	UQQ-3.3/25-Q12	UQQ-3.3/25-Q48	UQQ-5/17-Q12	UQQ-5/20-Q48	UQQ-12/8-Q12	UQQ-12/8-Q48	UQQ-15/7-Q12	UQQ-24/4-Q12
<b>DYNAMIC CHARACTERISTICS</b>								
<b>Dynamic Load Response</b> (50-75-50% load step)	50µsec to ±1% of final value	100µsec to ±1% of final value		50µsec to ±1% of final value		95µsec to ±1% of final value	50µsec to ±1% of final value	50µsec to ±2% of final value
<b>Start-up Time</b>								
VIN to VOUT regulated	10msec	10msec max	10msec	25msec	10msec	20msec	10msec	10msec
Remote On/Off to VOUT regulated	5msec	5msec max	5msec					
Switching frequency	255 ±25kHz	255 ±25kHz	260 ±25kHz	225-265kHz	260 ±25kHz	245 ±20kHz	260 ±25kHz	260 ±25kHz
<b>ENVIRONMENTAL</b>								
<b>Calculated MTBF (4)</b>	TBC							
<b>Operating Temperature Range</b> See Derating curves	-40 to +85°C with Derating					-40 to +57°C with Derating	-40 to +85°C with Derating	
<b>Operating Temperature Range</b> with baseplate (no Derating required) (3)(14)	-40 to +105°C	-40 to +100°C	-40 to +105°C	-40 to +105°C	-40 to +105°C	-40 to +100°C	-40 to +105°C	-40 to +105°C
<b>Storage Temperature Range</b>	-55 to +125°C							
<b>Thermal Protection/Shutdown</b>	+120°C, measured at thermistor T1							
<b>Relative humidity</b>	To +85°C/85% non-condensing							
<b>PHYSICAL</b>								
Outline dimensions	See mechanical specifications							
Baseplate material	Aluminum							
Pin material	Copper alloy							
Pin diameter	0.04/0.062 inches, 1.016/1.524 mm							
Weight	1 ounce (28 grams)							
Electromagnetic interference (conducted, external filter required)	Designed to meet class B, EN55022, CISPR22							
Safety	Certified to UL/cUL 60950-1, CSA-C22.2 No.60950-1, IEC/EN 60950-1, 2nd Edition							
Flammability	UL 94V-0							

#### Specification Notes:

- (1) All models are tested and specified with 300 lfm airflow, external 1 and 10µF paralleled ceramic/tantalum output capacitors and a 100µF external input capacitor. All capacitors are low ESR types. These capacitors are necessary to accommodate our test equipment and may not be required in your applications. All models are stable and regulate within spec under no-load conditions.  
General conditions for Specifications are +25°C, VIN = nominal, VOUT = nominal, full load unless noted.
- (2) Input Ripple Current is tested and specified over a 5Hz to 20MHz bandwidth. Input filtering is CIN = 33µF tantalum, CBUS = 220µF electrolytic, LBUS = 12µH.
- (3) Note that Maximum Power Derating curves indicate an average current at nominal input voltage. At higher temperatures and/or lower airflow, the DC/DC converter will tolerate brief full current outputs if the total RMS current over time does not exceed the Derating curve. All Derating curves are presented at sea level altitude. Be aware of reduced power dissipation with increasing altitude.
- (4) Mean Time Before Failure is calculated using the Telcordia (Belcore) SR-332 Method 1, Case 3, ground fixed conditions, TPCBOARD = +25°C, full output load, natural air convection.
- (5) The On/Off Control may be driven with external logic or by applying appropriate external voltages which are referenced to Input Common. The On/Off Control Input should use either an open collector/open drain transistor or logic gate.
- (6) Short circuit shutdown begins when the output voltage degrades approximately 2% from the selected setting.
- (7) The outputs are not intended to sink appreciable reverse current.
- (8) Output noise may be further reduced by adding an external filter. See I/O Filtering and Noise Reduction.
- (9) All models are fully operational and meet published specifications, including "cold start" at -40°C. On-board component package temperatures must not exceed +128°C.
- (10) Regulation specifications describe the deviation as the line input voltage or output load current is varied from a nominal midpoint value to either extreme.
- (11) Alternate pin length and/or other output voltages are available under special quantity order.
- (12) Overvoltage shutdown on 48V input models can be eliminated under special quantity order. OV shutdown can be deleted in order to comply with certain telecom reliability requirements. These requirements attempt continued operation despite significant input overvoltage.
- (13) Do not exceed maximum power specifications when adjusting the output trim.
- (14) Note that the converter may operate up to +105°C with the baseplate installed (+100°C for the UQQ-3.3/25-Q48). However, thermal self-protection occurs near +120°C. Therefore, +105°C is recommended to avoid thermal shutdown.
- (15) If reverse polarity is accidentally applied to the input, to ensure reverse input protection, always connect an external input fuse in series with the +VIN input. Use approximately twice the full input current rating with nominal input voltage.
- (16) For On/Off Control on negative-polarity UQQ-3.3/25-Q48N models, the maximum OFF mode control voltage is +13.5 Volts. For the ON mode, the range is pin grounded to +1 Volt max.
- (17) *Always* connect the sense pins. If they are not connected to a remote load, connect each sense pin to its respective output at the converter pins.

**MECHANICAL SPECIFICATIONS**



DOSAs-Compatible Input/Output Connections	
Pin	Function P32
1	-Input*
2	Remote On/Off**
3	+Input*
4	-Output
5	-Sense
6	Output Trim
7	+Sense
8	+Output
9	Baseplate (optional)

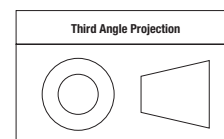
\* These converters are pin-for-pin/plug-compatible to competitive units. Other units may use different pin numbering or alternate outline views. When laying out your PC board, follow the pin FUNCTION. DOSA designates Pin 1 as +Input and Pin 3 as -Input.

\*\* The Remote On/Off can be provided with either positive ("P" suffix) or negative ("N" suffix) polarity.

Important! *Always* connect the sense pins; see Application Notes.

Standard pin length is shown. Please refer to the Part Number Structure for alternate pin lengths.

Dimensions are in inches (mm shown for ref. only).

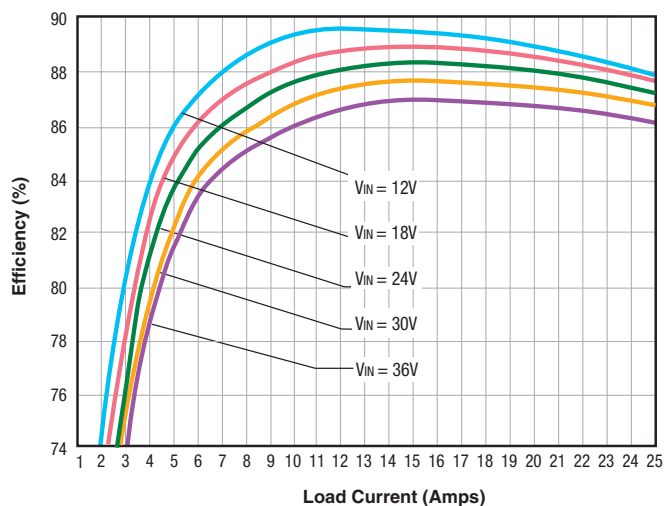


Tolerances (unless otherwise specified):  
 .XX  $\pm$  0.02 (0.5)  
 .XXX  $\pm$  0.010 (0.25)  
 Angles  $\pm$  2°

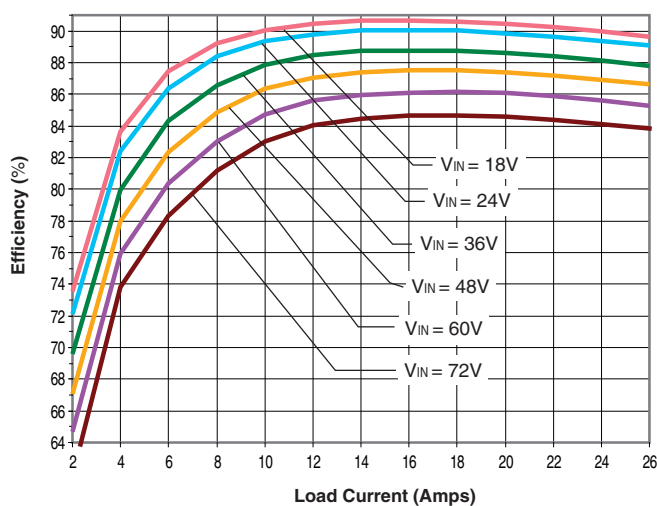
Components are shown for reference only.

**TYPICAL PERFORMANCE DATA**

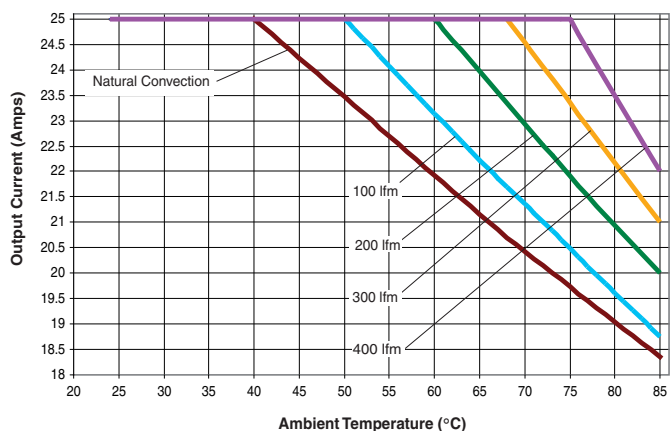
**UQQ-3.3/25-Q12**  
Efficiency vs. Line Voltage and Load Current @ 25°C



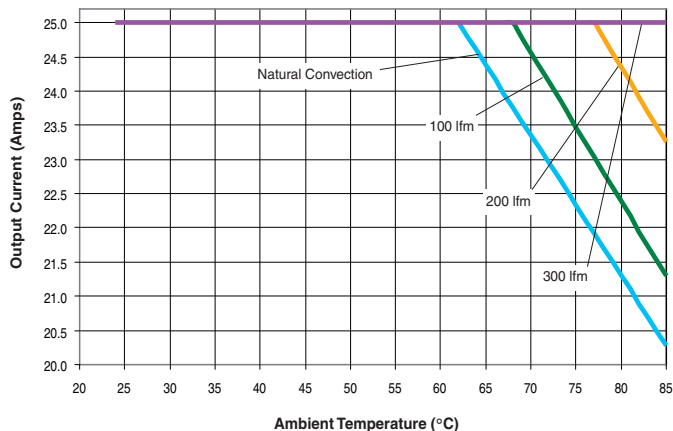
**UQQ-3.3/25-Q48P**  
Efficiency vs. Line Voltage and Load Current @ 25°C



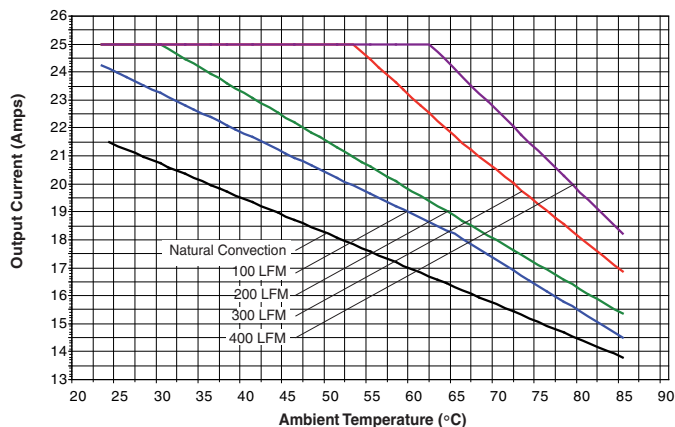
**UQQ-3.3/25-Q12P** Maximum Current Temperature Derating  
(no baseplate, VIN = 12V, air flow is transverse)



**UQQ-3.3/25-Q12PB** Maximum Current Temperature Derating  
(with baseplate, VIN = 12V, air flow is transverse)

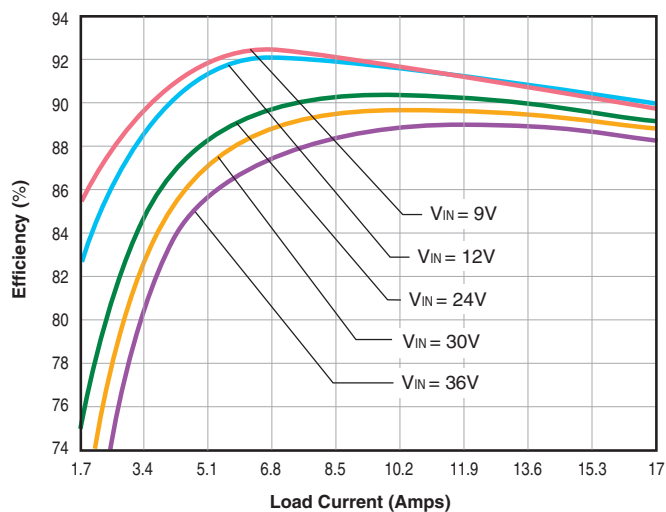


**UQQ-3.3/25-Q48** Maximum Current Temperature Derating at sea level  
(VIN = 48V, with baseplate, transverse air flow)

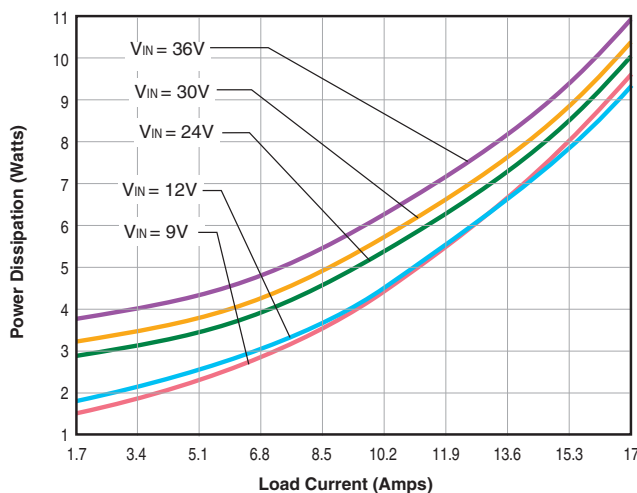


**TYPICAL PERFORMANCE DATA**

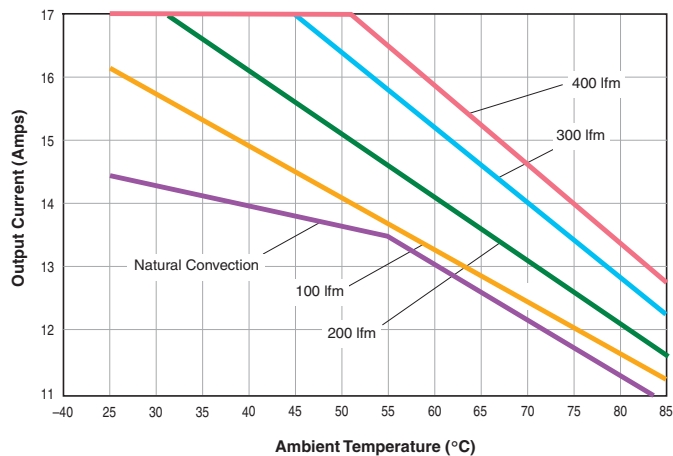
**UQQ-5/17-Q12P**  
Efficiency vs. Line Voltage and Load Current @ 25°C



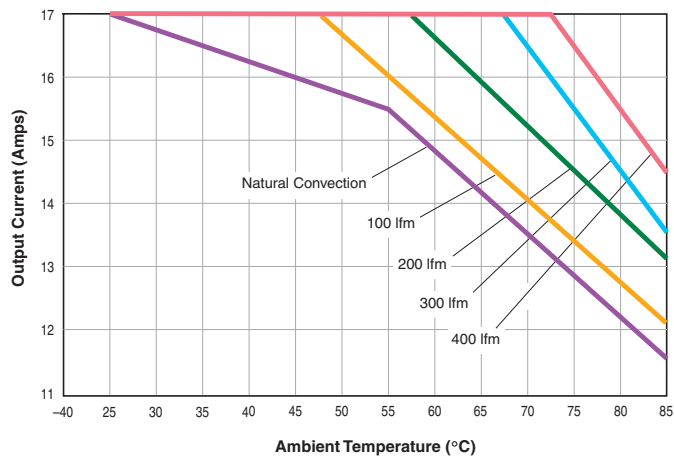
**UQQ-5/17-Q12P**  
Power Dissipation vs. Load Current @ 25°C



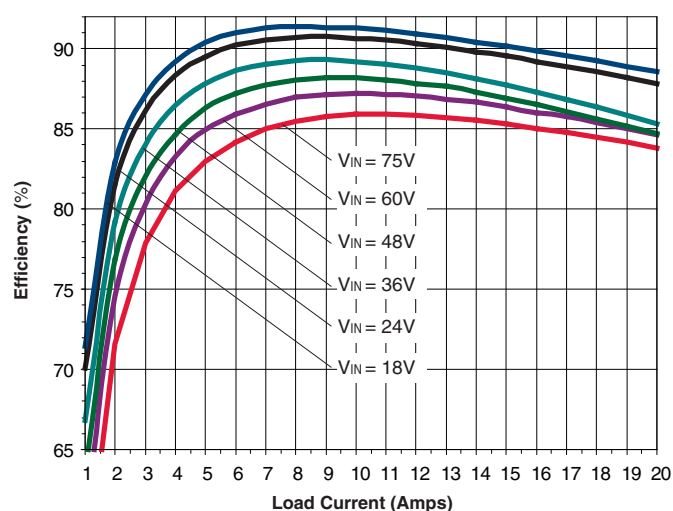
**UQQ-5/17-Q12P Maximum Current Temperature Derating**  
No baseplate, VIN = 12V (transverse air flow at sea level)



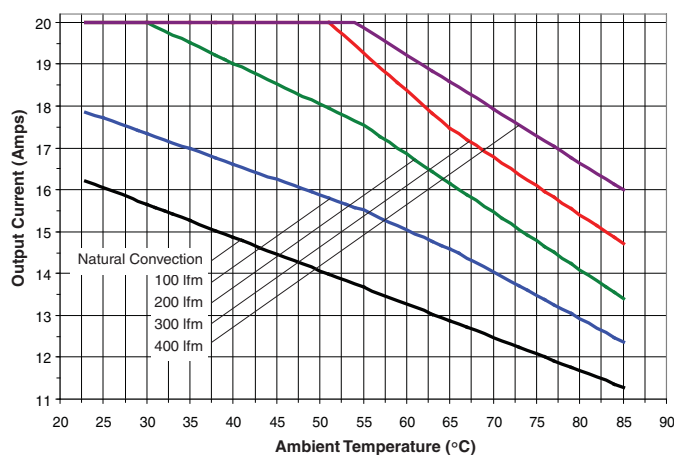
**UQQ-5/17-Q12P Maximum Current Temperature Derating**  
With baseplate, VIN = 12V (transverse air flow at sea level)



**UQQ-5/20-Q48P**  
Efficiency vs. Line Voltage and Load Current @ 25°C



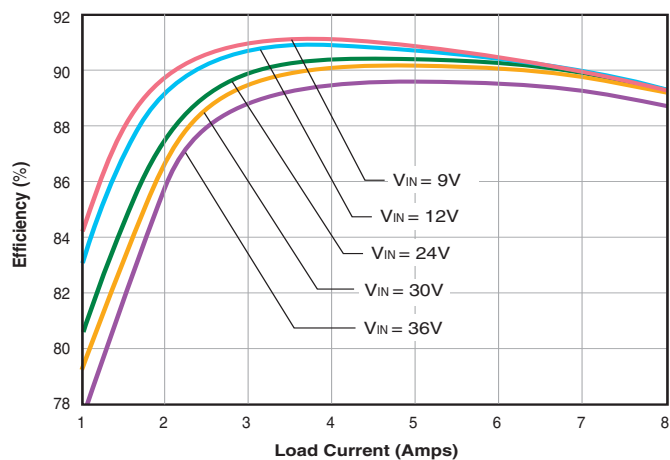
**UQQ-5/20-Q48P Maximum Current Temperature Derating at sea level**  
(VIN = 48V, with baseplate, transverse airflow)



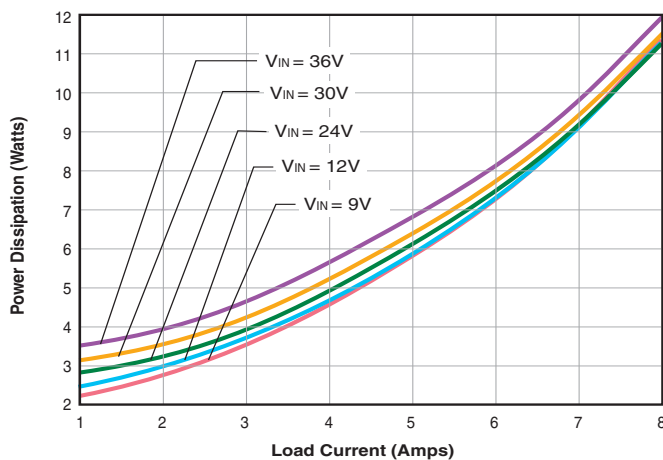


**TYPICAL PERFORMANCE DATA**

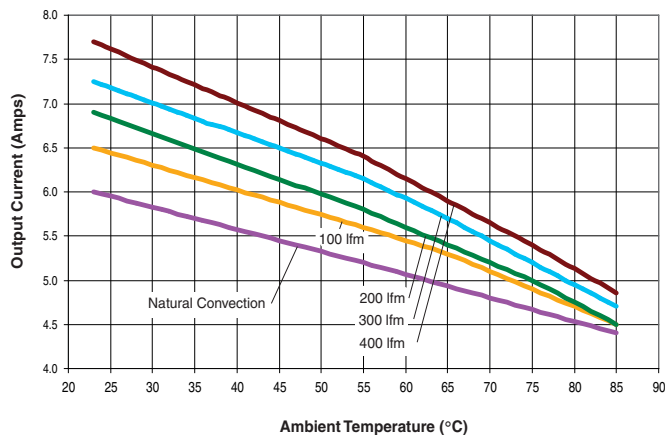
**UQQ-12/8-Q12P**  
Efficiency vs. Line Voltage and Load Current @ 25°C



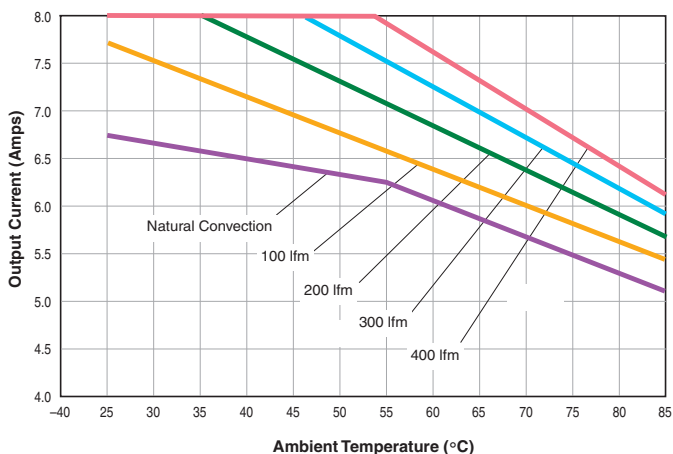
**UQQ-12/8-Q12**  
Power Dissipation vs. Load Current @ 25°C



**UQQ-12/8-Q12P Maximum Current Temperature Derating**  
(no baseplate,  $V_{IN} = 12V$ , air flow is transverse)

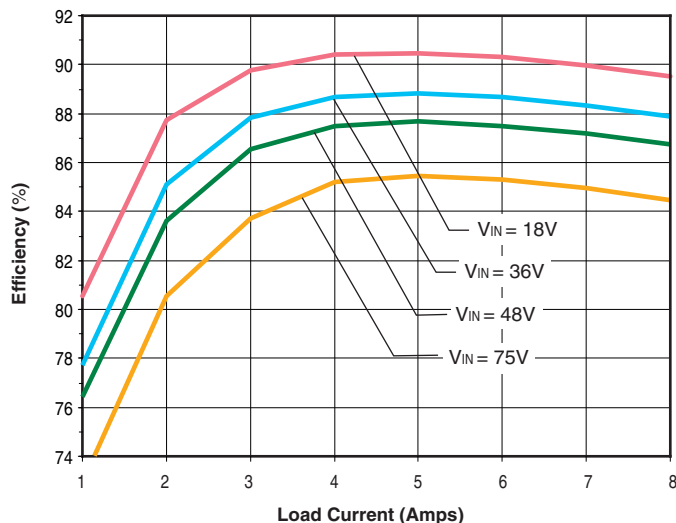


**UQQ-12/8-Q12P Maximum Current Temperature Derating**  
With baseplate,  $V_{IN} = 12V$  (transverse air flow at sea level)

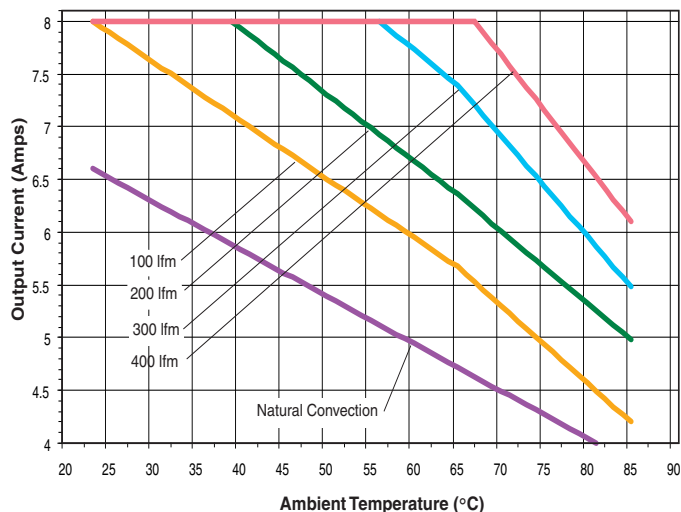


**TYPICAL PERFORMANCE DATA**

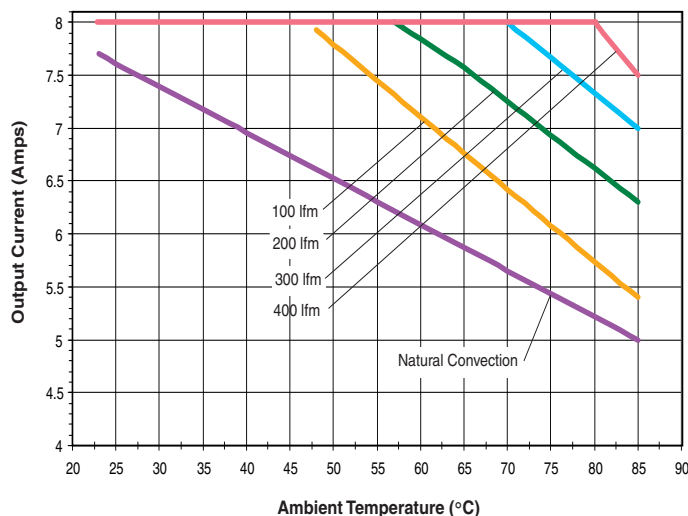
**UQQ-12/8-Q48P**  
Efficiency vs. Line Voltage and Load Current @ 25°C



**UQQ-12/8-Q48P Maximum Current Temperature Derating**  
(With baseplate, V<sub>IN</sub> = 48V transverse air flow at sea level)

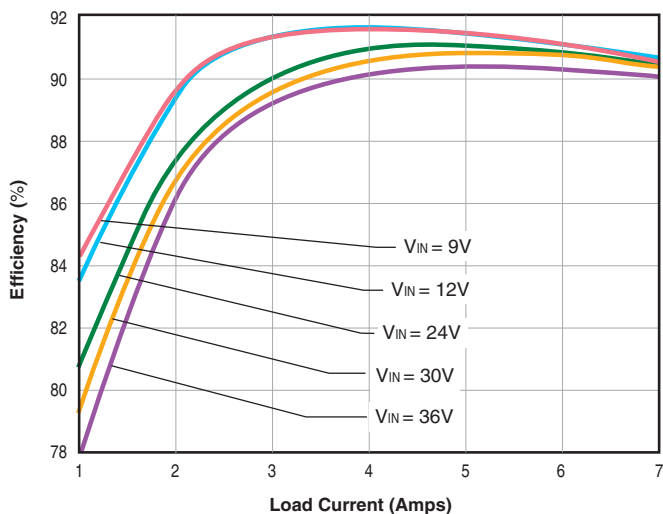


**UQQ-12/8-Q48P Maximum Current Temperature Derating**  
(With baseplate, V<sub>IN</sub> = 24V, transverse air flow at sea level)

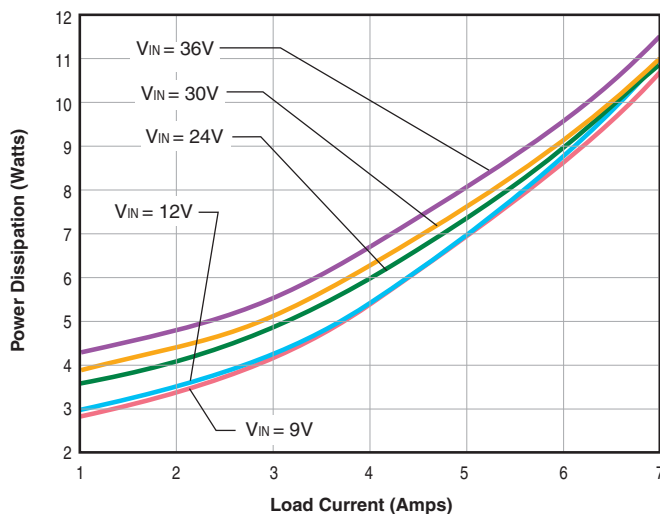


**TYPICAL PERFORMANCE DATA**

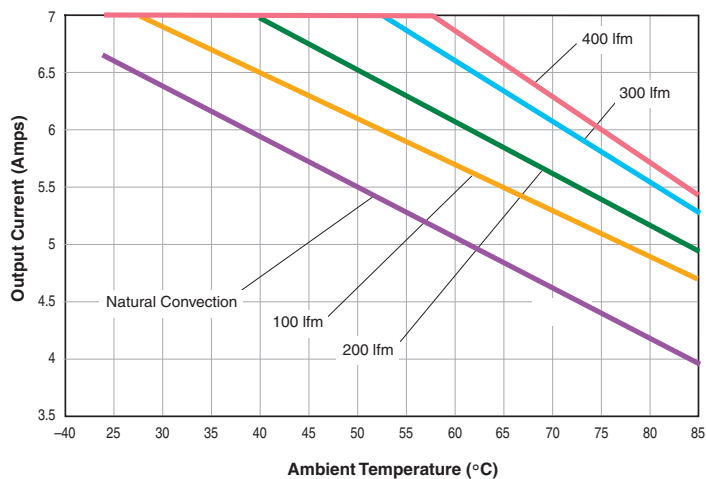
**UQQ-15/7-Q12P**  
Efficiency vs. Line Voltage and Load Current @ 25°C



**UQQ-15/7-Q12P**  
Power Dissipation vs. Load Current @ 25°C

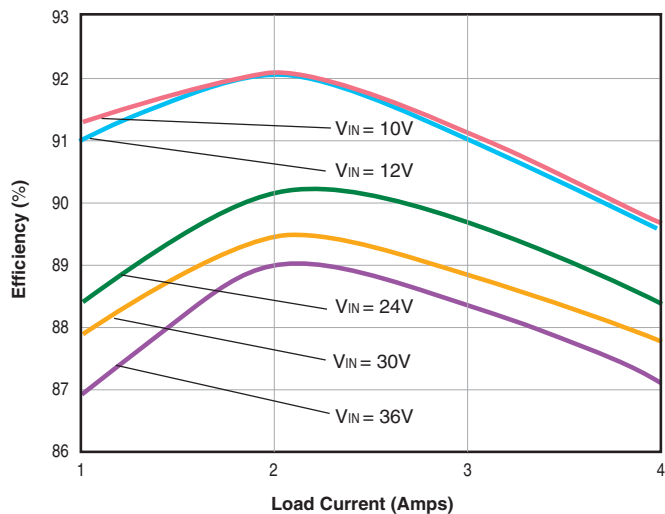


**UQQ-15/7-Q12P Maximum Current Temperature Derating**  
With baseplate, V<sub>IN</sub> = 12V (transverse air flow at sea level)

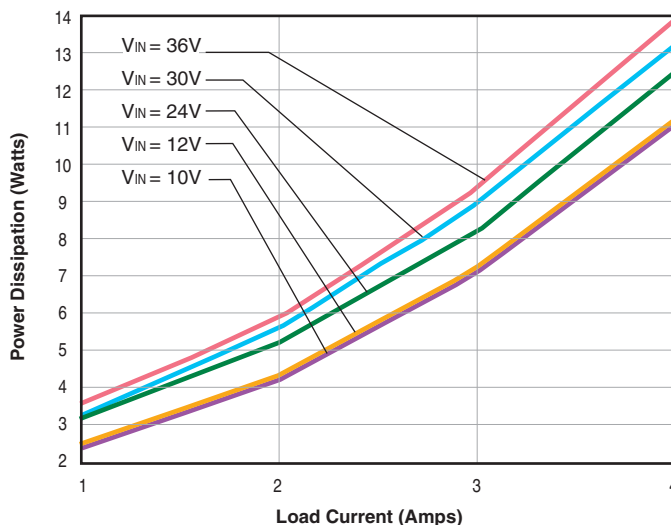


**TYPICAL PERFORMANCE DATA**

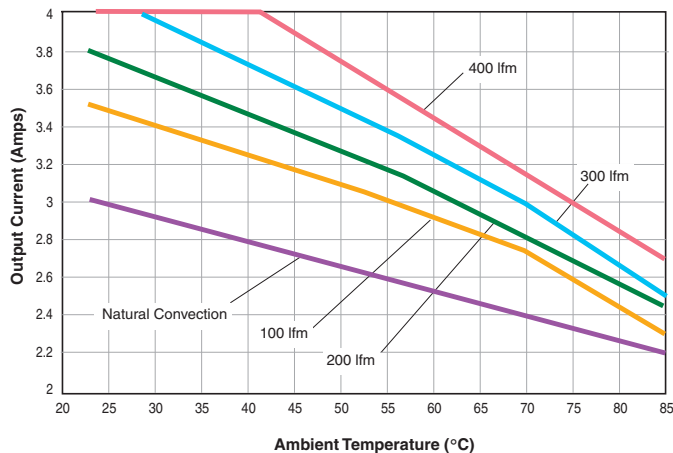
**UQQ-24/4-Q12P**  
Efficiency vs. Line Voltage and Load Current @ 25°C



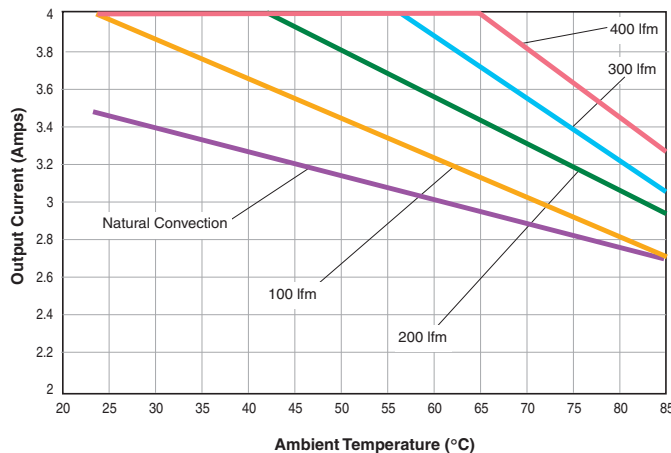
**UQQ-24/4-Q12P**  
Power Dissipation vs. Load Current @ 25°C



**UQQ-24/4-Q12P Maximum Current Temperature Derating**  
No baseplate,  $V_{IN} = 12V$  (transverse air flow at sea level)



**UQQ-24/4-Q12P Maximum Current Temperature Derating**  
With baseplate,  $V_{IN} = 12V$  (transverse air flow at sea level)



**Technical Notes**

**Soldering Guidelines**

Murata Power Solutions recommends the specifications below when installing these converters. These specifications vary depending on the solder type. Exceeding these specifications may cause damage to the product. Your production environment may differ; therefore please thoroughly review these guidelines with your process engineers.

**Wave Solder Operations for through-hole mounted products (THMT)**

For Sn/Ag/Cu based solders:		For Sn/Pb based solders:	
Maximum Preheat Temperature	115° C.	Maximum Preheat Temperature	105° C.
Maximum Pot Temperature	270° C.	Maximum Pot Temperature	250° C.
Maximum Solder Dwell Time	7 seconds	Maximum Solder Dwell Time	6 seconds

**Removal of Soldered UQQ's from Printed Circuit Boards**

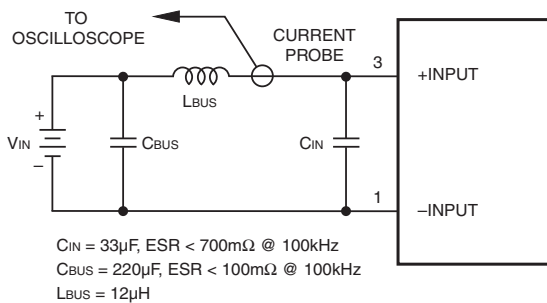
Should removal of the UQQ from its soldered connection be needed, thoroughly de-solder the pins using solder wicks or de-soldering tools. At no time should any prying or leverage be used to remove boards that have not been properly de-soldered first.

**Input Source Impedance**

UQQ converters must be driven from a low ac-impedance input source. The DC/DC's performance and stability can be compromised by the use of highly inductive source impedances. The input circuit shown in Figure 2 is a practical solution that can be used to minimize the effects of inductance in the input traces. For optimum performance, components should be mounted close to the DC/DC converter.

**I/O Filtering, Input Ripple Current, and Output Noise**

All models in the UQQ Series are tested/specified for input ripple current (also called input reflected ripple current) and output noise using the circuits and layout shown in Figures 2 and 3. External input capacitors ( $C_{IN}$  in Figure 2) serve primarily as energy-storage elements.

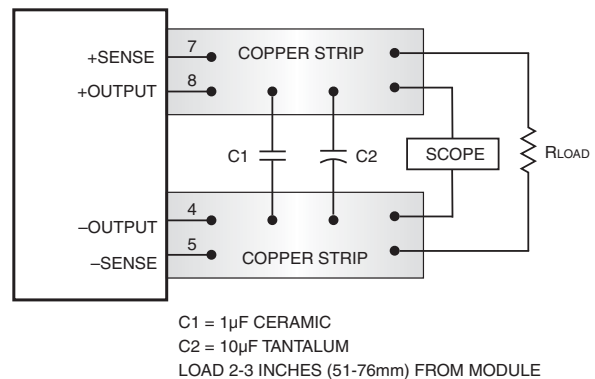


**Figure 2. Measuring Input Ripple Current**

They should be selected for bulk capacitance (at appropriate frequencies), low ESR, and high rms-ripple-current ratings. The switching nature of DC/DC converters requires that dc voltage sources have low ac impedance as highly inductive source impedance can affect system stability. In Figure 2,  $C_{BUS}$  and  $L_{BUS}$  simulate a typical dc voltage bus. Your specific system configuration may necessitate additional considerations.

In critical applications, output ripple/noise (also referred to as periodic and random deviations or PARD) can be reduced below specified limits using filtering techniques, the simplest of which is the installation of additional external output capacitors. Output capacitors function as true filter elements and should be selected for bulk capacitance, low ESR, and appropriate frequency response. In Figure 3, the two copper strips simulate real-world pcb impedances between the power supply and its load. Scope measurements should be made using BNC connectors or the probe ground should be less than 1/2 inch and soldered directly to the fixture.

All external capacitors should have appropriate voltage ratings and be located as close to the converter as possible. Temperature variations for all relevant parameters should be taken into consideration. OS-CON™ organic semiconductor capacitors (www.sanyo.com) can be especially effective for further reduction of ripple/noise. The most effective combination of external I/O capacitors will be a function of line voltage and source impedance, as well as particular load and layout conditions.



**Figure 3. Measuring Output Ripple/Noise (PARD)**

**Start-Up Threshold and Undervoltage Shutdown**

Under normal start-up conditions, the UQQ Series will not begin to regulate properly until the ramping input voltage exceeds the Start-Up Threshold. Once operating, devices will turn off when the applied voltage drops below the Undervoltage Shutdown point. Devices will remain off as long as the undervoltage condition continues. Units will automatically re-start when the applied voltage is brought back above the Start-Up Threshold. The hysteresis built into this function avoids an indeterminate on/off condition at a single input voltage. See Performance/Functional Specifications table for actual limits.

**Start-Up Time**

The  $V_{IN}$  to  $V_{OUT}$  Start-Up Time is the interval between the point at which a ramping input voltage crosses the Start-Up Threshold voltage and the point at which the fully loaded output voltage enters and remains within its specified accuracy band. Actual measured times will vary with input source impedance, external input capacitance, and the slew rate and final value of the input voltage as it appears to the converter. The On/Off to  $V_{OUT}$  start-up time assumes that the converter is turned off via the Remote On/Off Control with the nominal input voltage already applied.

**On/Off Control**

The primary-side, Remote On/Off Control function (pin 2) can be specified to operate with either positive or negative polarity. Positive-polarity devices ("P" suffix) are enabled when pin 2 is left open or is pulled high. Positive-polarity devices are disabled when pin 2 is pulled low or left open (with respect to -Input). Negative-polarity devices are off when pin 2 is high and on when pin 2 is pulled low or grounded. See Figure 4.

Dynamic control of the remote on/off function is best accomplished with a mechanical relay or an open-collector/open-drain drive circuit (optically isolated if appropriate). The drive circuit should be able to sink appropriate current (see Performance Specifications) when activated and withstand appropriate voltage when deactivated.

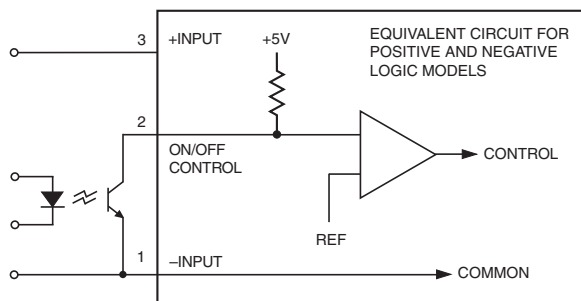


Figure 4. Driving the Remote On/Off Control Pin

**Sense Input**

Note: The sense and  $V_{OUT}$  lines are internally connected through low-value resistors. Nevertheless, if sense is not used for remote regulation, the user must connect + sense to +  $V_{OUT}$  and -sense to - $V_{OUT}$  at the converter pins. Sense is intended to correct small output accuracy errors caused by the resistive ohmic drop in output wiring as output current increases. This output drop (the difference between Sense and  $V_{OUT}$  when measured at the converter)

should not be allowed to exceed 0.5V. Consider using heavier wire if this drop is excessive.

Sense is connected at the load and corrects for resistive errors only. Be careful where it is connected. Any long, distributed wiring and/or significant inductance introduced into the Sense control loop can adversely affect overall system stability. If in doubt, test the application, and observe the DC/DC's output transient response during step loads. There should be no appreciable ringing or oscillation. You may also adjust the output trim slightly to compensate for voltage loss in any external filter elements. Do not exceed maximum power ratings.

**Current Limiting**

When power demands from the output falls within the current limit inception range for the rated output current, the DC/DC converter will go into a current limiting mode. In this condition the output voltage will decrease proportionately with increases in output current, thereby maintaining a somewhat constant power dissipation. This is commonly referred to as power limiting. Current limit inception is defined as the point where the full-power output voltage falls below the specified tolerance. If the load current being drawn from the converter is significant enough, the unit will go into a short circuit condition. See "Short Circuit Condition."

**Short Circuit Condition**

When a converter is in current limit mode the output voltages will drop as the output current demand increases. If the output voltage drops too low, the magnetically coupled voltage used to develop primary side voltages will also drop, thereby shutting down the PWM controller. Following a time-out period of about 50 milliseconds, the PWM will restart, causing the output voltages to begin ramping to their appropriate values. If the short-circuit condition persists, another shutdown cycle will be initiated. This on/off cycling is referred to as "hiccup" mode. The hiccup cycling reduces the average output current, thereby preventing internal temperatures from rising to excessive levels. The UQQ is capable of enduring an indefinite short circuit output condition.

**Thermal Shutdown**

UQQ converters are equipped with thermal-shutdown circuitry. If the internal temperature of the DC/DC converter rises above the designed operating temperature (See Performance Specifications), a precision temperature sensor will power down the unit. When the internal temperature decreases below the threshold of the temperature sensor, the unit will self start.

**Output Overvoltage Protection**

The output voltage is monitored for an overvoltage condition via magnetic coupling to the primary side. If the output voltage rises to a fault condition, which could be damaging to the load circuitry (see Performance Specifications), the sensing circuitry will power down the PWM controller causing the output voltage to decrease. Following a time-out period the PWM will restart, causing the output voltage to ramp to its appropriate value. If the fault condition persists, and the output voltages again climb to excessive levels, the overvoltage circuitry will initiate another shutdown cycle. This on/off cycling is referred to as "hiccup" mode.

**Input Reverse-Polarity Protection**

If the input-voltage polarity is accidentally reversed, an internal diode will become forward biased and likely draw excessive current from the power source. If the source is not current limited or the circuit appropriately fused, it could cause permanent damage to the converter.

**Input Fusing**

Certain applications and/or safety agencies may require the installation of fuses at the inputs of power conversion components. Fuses should also be used if the possibility of a sustained, non-current-limited, input-voltage polarity reversal exists. For MPS UQQ Series DC/DC Converters, fast-blow fuses are recommended with values no greater than twice the maximum input current.

**Trimming Output Voltage**

UQQ converters have a trim capability (pin 6) that enables users to adjust the output voltage from +10% to -20% (refer to the trim equations). Adjustments to the output voltage can be accomplished with a single fixed resistor as shown in Figures 5 and 6. A single fixed resistor can increase or decrease the output voltage depending on its connection. Resistors should be located close to the converter and have TCR's less than 100ppm/°C to minimize sensitivity to changes in temperature. If the trim function is not used, leave the trim pin open.

Standard UQQ's have a "positive trim" where a single resistor connected from the Trim pin (pin 6) to the +Sense (pin 7) will increase the output voltage. A resistor connected from the Trim Pin (pin 6) to the -Sense (pin 5) will decrease the output voltage.

Trim adjustments greater than the specified +10%/-20% can have an adverse affect on the converter's performance and are not recommended. Excessive voltage differences between  $V_{OUT}$  and Sense, in conjunction with trim adjustment of the output voltage, can cause the overvoltage protection circuitry to activate (see Performance Specifications for overvoltage limits).

Temperature/power derating is based on maximum output current and voltage at the converter's output pins. Use of the trim and sense functions can cause output voltages to increase, thereby increasing output power beyond the UQQ's specified rating, or cause output voltages to climb into the output overvoltage region. Therefore:

$$(V_{out \text{ at pins}}) \times (I_{out}) \leq \text{rated output power}$$

The Trim pin (pin 6) is a relatively high impedance node that can be susceptible to noise pickup when connected to long conductors in noisy environments.

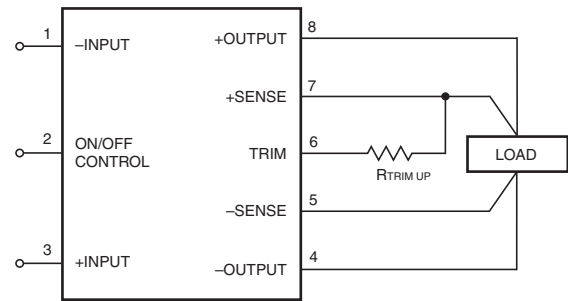


Figure 5. Trim Connections To Increase Output Voltages Using Fixed Resistors

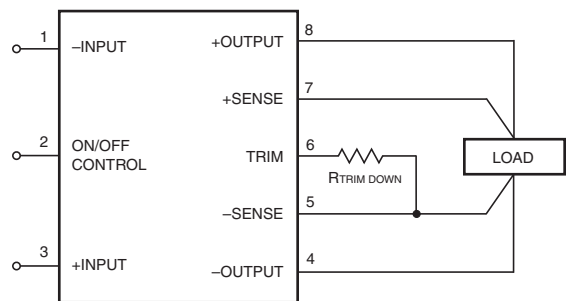


Figure 6. Trim Connections To Decrease Output Voltages Using Fixed Resistors

Trim Up	Trim Down
<b>UQQ-3.3/25-Q12, UQQ-3.3/25-Q48</b>	
$R_{T\_UP} (k\Omega) = \frac{13.3(V_O - 1.226)}{V_O - 3.3} - 10.2$	$R_{T\_DOWN} (k\Omega) = \frac{16.31}{3.3 - V_O} - 10.2$
<b>UQQ-5/17-Q12, UQQ-5/20-Q48</b>	
$R_{T\_UP} (k\Omega) = \frac{20.4(V_O - 1.226)}{V_O - 5} - 10.2$	$R_{T\_DOWN} (k\Omega) = \frac{25.01}{5 - V_O} - 10.2$
<b>UQQ-12/8-Q12, UQQ-12/8-Q48</b>	
$R_{T\_UP} (k\Omega) = \frac{49.6(V_O - 1.226)}{V_O - 12} - 10.2$	$R_{T\_DOWN} (k\Omega) = \frac{60.45}{12 - V_O} - 10.2$
<b>UQQ-15/7-Q12</b>	
$R_{T\_UP} (k\Omega) = \frac{62.9(V_O - 1.226)}{V_O - 15} - 10.2$	$R_{T\_DOWN} (k\Omega) = \frac{76.56}{15 - V_O} - 10.2$
<b>UQQ-24/4-Q12</b>	
$R_{T\_UP} (k\Omega) = \frac{101 \times (V_O - 1.226)}{V_O - 24} - 10.2$	$R_{T\_DOWN} (k\Omega) = \frac{124.2}{24 - V_O} - 10.2$

**UQQ Series Aluminum Heatsink**

Please note – The UQQ series shares the same heatsink kits as the UVQ series. Therefore, when ordering these heat sinks, use the model numbers below which end with the ‘UVQ’ suffix. The UQQ series converter baseplate can be attached either to an enclosure wall or a heatsink to remove heat from internal power dissipation. The discussion below concerns only the heatsink alternative. The UQQ’s are available with a low-profile extruded aluminum heatsink kit, models HS-QB25-UVQ, HS-QB50-UVQ, and HS-QB100-UVQ.

This kit includes the heatsink, thermal mounting pad, screws and mounting hardware. See the assembly diagram below. Do not overtighten the screws in the tapped holes in the converter. This kit adds excellent thermal performance without sacrificing too much component height. See the Mechanical Outline Drawings for assembled dimensions. If the thermal pad is firmly attached, no thermal compound (“thermal grease”) is required.

When assembling these kits onto the converter, include ALL kit hardware to assure adequate mechanical capture and proper clearances. Thread relief is 0.090" (2.3mm).

**Thermal Performance**

The HS-QB25-UVQ heatsink has a thermal resistance of 12 degrees Celsius per Watt of internal heat dissipation with “natural convection” airflow (no fans or other mechanical airflow) at sea level altitude. This thermal resistance assumes that the heatsink is firmly attached using the supplied thermal pad and that there is no nearby wall or enclosure surface to inhibit the airflow. The thermal pad adds a negligible series resistance of approximately 0.5°C/Watt so that the total assembled resistance is 12.5°C/Watt.

Be aware that we need to handle only the internal heat dissipation, not the full power output of the converter. This internal heat dissipation is related to the efficiency as follows:

$$\text{Power Dissipation [Pd]} = \text{Power In} - \text{Power Out} \quad [1]$$

$$\text{Power Out} / \text{Power In} = \text{Efficiency [in \%]} / 100 \quad [2]$$

$$\text{Power Dissipation [Pd]} = \text{Power In} \times (1 - \text{Efficiency\%/100}) \quad [3]$$

$$\text{Power Dissipation [Pd]} = \text{Power Out} \times (1 / (\text{Efficiency\%/100}) - 1) \quad [4]$$

Efficiency of course varies with input voltage and the total output power. Please refer to the Performance Curves.

Since many applications do include fans, here is an approximate equation to calculate the net thermal resistance:

$$R_{\Theta} [\text{at airflow}] = R_{\Theta} [\text{natural convection}] / (1 + (\text{Airflow in LFM}) \times [\text{Airflow Constant}]) \quad [5]$$

Where,

$R_{\Theta} [\text{at airflow}]$  is the net thermal resistance (in °C/W) with the amount of airflow available and,

$R_{\Theta} [\text{natural convection}]$  is the still air total path thermal resistance or in this case 12.5°C/Watt and,

“Airflow in LFM” is the net air movement flow rate immediately at the converter.

This equation simplifies an otherwise complex aerodynamic model but is a useful starting point. The “Airflow Constant” is dependent on the fan and enclosure geometry. For example, if 200 LFM of airflow reduces the effective natural convection thermal resistance by one half, the airflow constant would be 0.005. There is no practical way to publish a “one size fits all” airflow constant because of variations in airflow direction, heatsink orientation, adjacent walls, enclosure geometry, etc. Each application must be determined empirically and the equation is primarily a way to help understand the cooling arithmetic.

This equation basically says that small amounts of forced airflow are quite effective removing the heat. But very high airflows give diminishing returns. Conversely, no forced airflow causes considerable heat buildup. At zero airflow, cooling occurs only because of natural convection over the heatsink. Natural convection is often well below 50 LFM, not much of a breeze.

While these equations are useful as a conceptual aid, most users find it very difficult to measure actual airflow rates at the converter. Even if you know the velocity specifications of the fan, this does not usually relate directly to the enclosure geometry. Be sure to use a considerable safety margin doing thermal analysis. If in doubt, measure the actual heat sink temperature with a calibrated thermocouple, RTD or thermistor. Safe operation should keep the heat sink below 100°C.

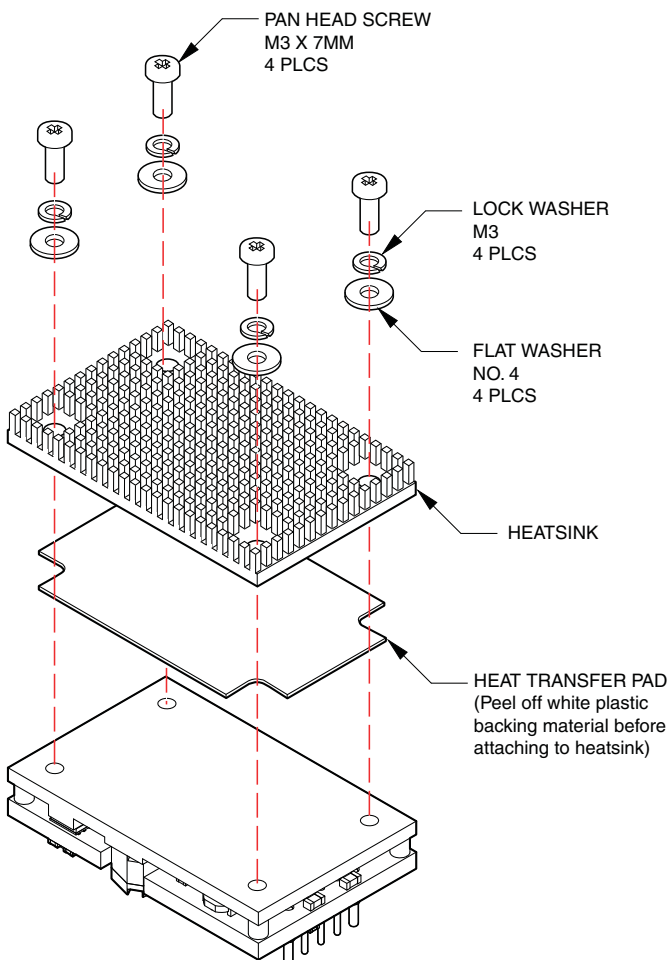


Figure 7. Model UQQ Heatsink Assembly Diagram



**Calculating Maximum Power Dissipation**

To determine the maximum amount of internal power dissipation, find the ambient temperature inside the enclosure and the airflow (in Linear Feet per Minute – LFM) at the converter. Determine the expected heat dissipation using the Efficiency curves and the converter Input Voltage. You should also compensate for lower atmospheric pressure if your application altitude is considerably above sea level.

The general procedure is to compute the expected temperature rise of the heatsink. If the heatsink exceeds +100°C, either increase the airflow and/or reduce the power output. Start with this equation:

$$\text{Internal Heat Dissipation [Pd in Watts]} = (T_s - T_a) / R_{\Theta} \text{ [at airflow]} \quad [6]$$

where “Ta” is the enclosure ambient air temperature and,

where “Ts” is the heatsink temperature and,

where “RΘ [at airflow]” is a specific heat transfer thermal resistance (in degrees Celsius per Watt) for a particular heat sink at a set airflow rate. We have already estimated RΘ [at airflow] in the equations above.

Note particularly that Ta is the air temperature inside the enclosure at the heatsink, not the outside air temperature. Most enclosures have higher internal temperatures, especially if the converter is “downwind” from other heat-producing circuits. Note also that this “Pd” term is only the internal heat dissipated inside the converter and not the total power output of the converter.

We can rearrange this equation to give an estimated temperature rise of the heatsink as follows:

$$T_s = (Pd \times R_{\Theta} \text{ [at airflow]}) + T_a \quad [7]$$

Heatsink Kit * Model Number	Still Air (Natural convection) thermal resistance	Heatsink height (see drawing)
HS-QB25-UVQ	12°C/Watt	0.25" (6.35mm)
HS-QB50-UVQ	10.6°C/Watt	0.50" (12.7mm)
HS-QB100-UVQ	8°C/Watt	1.00" (25.4mm)

\* Kit includes heatsink, thermal pad and mounting hardware. These are non-RoHS models. For RoHS-6 versions, add “-C” to the model number (e.g., HS-QB25-UVQ-C).

These model numbers are correct for the UQQ series.

**Heat Sink Example**

Assume an efficiency of 92% and power output of 100 Watts. Using equation [4], Pd is about 8.7 Watts at an input voltage of 48 Volts. Using +30°C ambient temperature inside the enclosure, we wish to limit the heat sink temperature to +90°C maximum baseplate temperature to stay well away from thermal shut-down. The +90°C figure also allows some margin in case the ambient climbs above +30°C or the input voltage varies, giving us less than 92% efficiency.

The heat sink and airflow combination must have the following characteristics:

$$8.7 \text{ W} = (90-30) / R_{\Theta}[\text{airflow}] \text{ or,}$$

$$R_{\Theta}[\text{airflow}] = 60/8.7 = 6.9^{\circ}\text{C/W}$$

Since the ambient thermal resistance of the heatsink and pad is 12.5°C/W, we need additional forced cooling to get us down to 6.9°C/W. Using a hypothetical airflow constant of 0.005, we can rearrange equation [5] as follows:

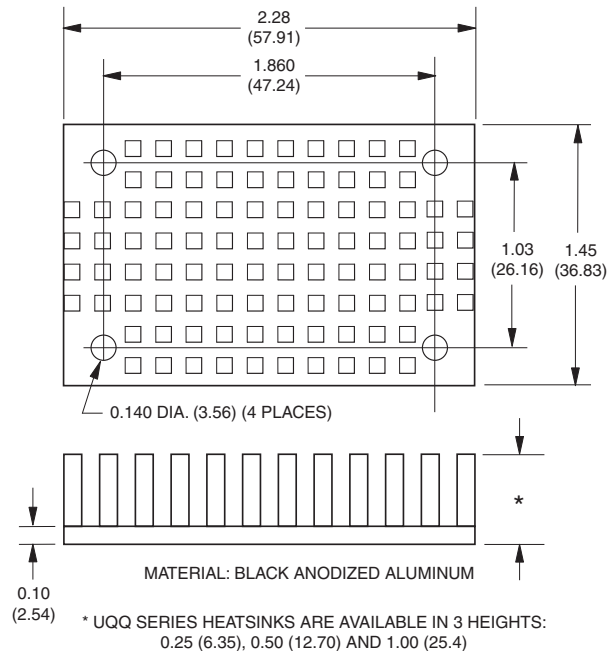
$$(\text{Required Airflow, LFM}) \times (\text{Airflow Constant}) = R_{\Theta}[\text{Nat.Convection}] / R_{\Theta}[\text{at airflow}] - 1, \text{ or,}$$

$$(\text{Required Airflow, LFM}) \times (\text{Airflow Constant}) = 12.5/6.9 - 1 = 0.81$$

and, rearranging again,

$$(\text{Required Airflow, LFM}) = 0.81/0.005 = 162 \text{ LFM}$$

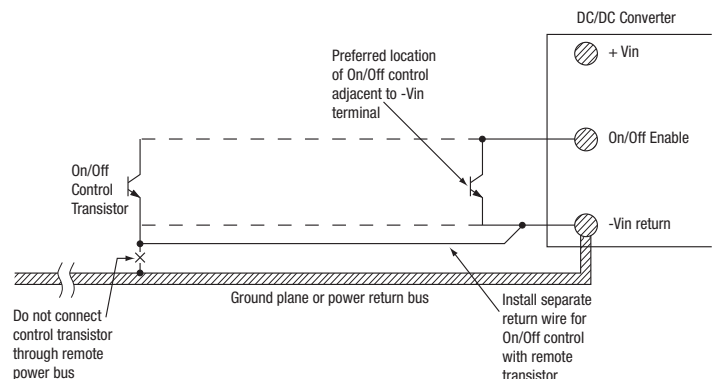
162 LFM is the minimum airflow to keep the heatsink below +90°C. Increase the airflow to several hundred LFM to reduce the heatsink temperature further and improve life and reliability.



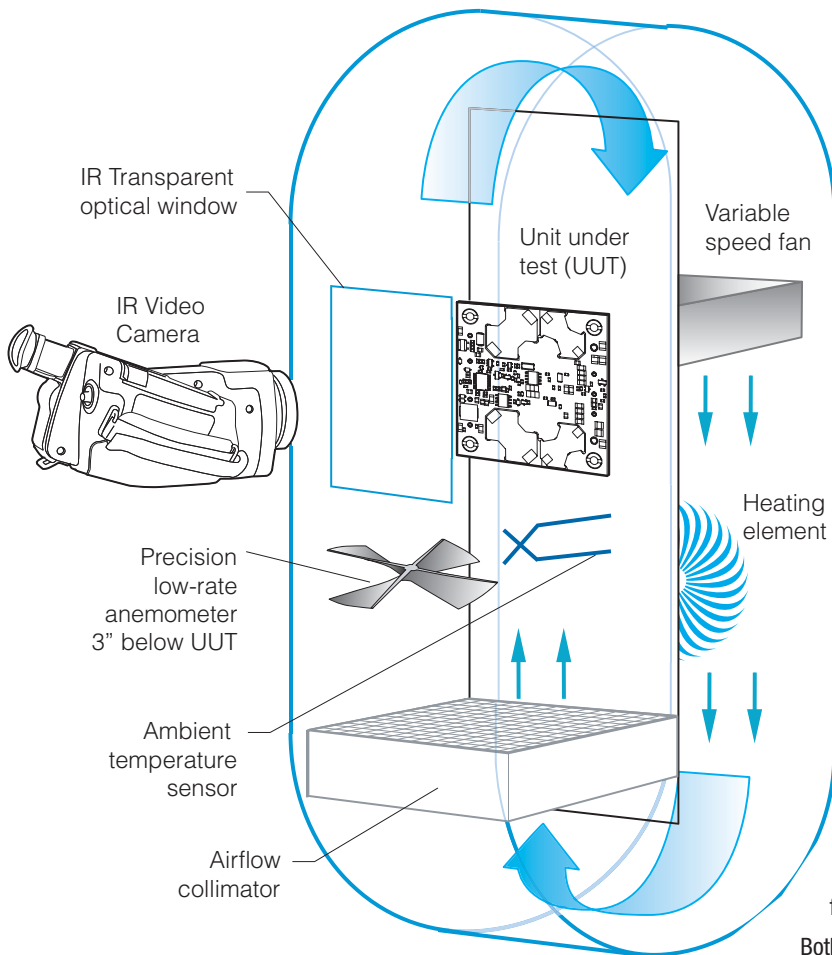
Dimensions in inches (mm)  
**Figure 8. Optional Heatsink**

**On/Off Enable Control Ground Bounce Protection**

To improve reliability, if you use a small signal transistor or other external circuit to select the Remote On/Off control, make sure to return the LO side directly to the -Vin power input on the DC/DC converter. To avoid ground bounce errors, do not connect the On/Off return to a distant ground plane or current-carrying bus. If necessary, run a separate small return wire directly to the -Vin terminal. There is very little current (typically 1-5 mA) on the On/Off control however, large current changes on a return ground plane or ground bus can accidentally trigger the converter on or off. If possible, mount the On/Off transistor or other control circuit adjacent to the converter.



**Figure 9. On/Off Enable Control Ground Bounce Protection**



**Figure 10. Vertical Wind Tunnel**

**Vertical Wind Tunnel**

Murata Power Solutions employs a custom-designed enclosed vertical wind tunnel, infrared video camera system and test instrumentation for accurate airflow and heat dissipation analysis of power products. The system includes a precision low flow-rate anemometer, variable speed fan, power supply input and load controls, temperature gauges and adjustable heating element.

The IR camera can watch thermal characteristics of the Unit Under Test (UUT) with both dynamic loads and static steady-state conditions. A special optical port is used which is transparent to infrared wavelengths. The computer files from the IR camera can be studied for later analysis.

Both through-hole and surface mount converters are soldered down to a host carrier board for realistic heat absorption and spreading. Both longitudinal and transverse airflow studies are possible by rotation of this carrier board since there are often significant differences in the heat dissipation in the two airflow directions. The combination of both adjustable airflow, adjustable ambient heat and adjustable Input/Output currents and voltages mean that a very wide range of measurement conditions can be studied.

The airflow collimator mixes the heat from the heating element to make uniform temperature distribution. The collimator also reduces the amount of turbulence adjacent to the UUT by restoring laminar airflow. Such turbulence can change the effective heat transfer characteristics and give false readings. Excess turbulence removes more heat from some surfaces and less heat from others, possibly causing uneven overheating.

Both sides of the UUT are studied since there are different thermal gradients on each side. The adjustable heating element and fan, built-in temperature gauges and no-contact IR camera mean that power supplies are tested in real-world conditions.